# life.augmented

# STF5N60M2

# N-channel 600 V, 1.3 Ω typ., 3.5 A MDmesh<sup>™</sup> M2 Power MOSFET in a TO-220FP package

Datasheet - production data

# TO-220FP

### Figure 1: Internal schematic diagram



# Features

Order code	VDS@ TJmax	RDS(on) max.	ID
STF5N60M2	650 V	1.4 Ω	3.5 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

# **Applications**

• Switching applications

# Description

This device is an N-channel Power MOSFET developed using MDmesh<sup>™</sup> M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

### Table 1: Device summary

Order code	Marking	Package	Packing
STF5N60M2	5N60M2	TO-220FP	Tube

DocID025320 Rev 2

This is information on a product in full production.

# Contents

# Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	TO-220FP package information	10
5	Revisio	on history	



# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
(1)	Drain current (continuous) at $T_C = 25$ °C	3.5	А
ID( '	Drain current (continuous) at Tc = 100 °C	2.2	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	14	А
P <sub>TOT</sub>	Total dissipation at $T_c = 25 \ ^{\circ}C$	20	W
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_C$ = 25 °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	15	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	v/ns
T <sub>stg</sub>	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	C

### Notes:

<sup>(1)</sup>Limited by package.

 $^{\left( 2\right) }$  Pulse width limited by safe operating area.

 $^{(3)}$  I\_{SD}  $\leq 3.5$  A, di/dt  $\leq 400$  A/µs; V\_Ds peak < V(BR)DSS, V\_DD = 400 V.

<sup>(4)</sup>  $V_{DS} \le 480 \text{ V}.$ 

# Table 3: Thermal data

Symbol	Symbol Parameter			
R <sub>thj-case</sub>	Thermal resistance junction-case max.	6.25	°C/W	
Rthj-amb	Thermal resistance junction-ambient max.	62.5	°C/W	

### **Table 4: Avalanche characteristics**

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	0.5	A
Eas	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}, I_D = I_{AR}; V_{DD} = 50 \text{ V}$ )	80	mJ



# 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5:	On /off	states
----------	---------	--------

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 V$ , $I_D = 1 mA$	600			V	
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 600 V$			1		
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{C} = 125 °C (1)$			100	μA	
Igss	Gate-body leakage current	$V_{DS} = 0 V$ , $V_{GS} = \pm 25 V$			±10	μA	
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	3	4	V	
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.7 \text{ A}$		1.3	1.4	Ω	

### Notes:

<sup>(1)</sup> Defined by design, not subject to production test.

Table 6: Dynamic							
Symbol	Symbol Parameter Test conditions				Max.	Unit	
Ciss	Input capacitance		-	211	-		
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	13	-	рF	
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0 V	-	0.75	-	Pi	
Coss eq. <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	19.5	-	pF	
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	6.2	-	Ω	
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 3.5 \text{ A},$	-	8	-		
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	1.6	-	nC	
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	4.4	-		

# Notes:

 $^{(1)}$  Coss  $_{eq.}$  is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDss.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 1.7 \text{ A R}_{G} = 4.7 \Omega,$	-	12	-	
tr	Rise time	$V_{GS} = 300$ V, $B = 1.7$ A $R_G = 4.7 \Omega$ , $V_{GS} = 10$ V (see Figure 14: "Test circuit for	-	3	-	
t <sub>d(off)</sub>	Turn-off delay time	resistive load switching times" and Figure 19: "Switching time waveform")	-	70	-	ns
t <sub>f</sub>	Fall time		-	15	-	

Table 7: Switching times



# Electrical characteristics

		Table 8: Source-drain diode		i.		
Symbol Parameter Test conditions		Min.	Тур.	Max.	Unit	
Isd	Source-drain current		-		3.5	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		14	А
Vsd <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 V$ , $I_{SD} = 3.5 A$	-		1.6	V
trr	Reverse recovery time	$I_{SD} = 3.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 60 \text{ V}$ (see Figure 16: "Test circuit for inductive load switching		220		ns
Qrr	Reverse recovery charge			1.05		μC
Irrm	Reverse recovery current	and diode recovery times")	-	9.5		А
trr	Reverse recovery time	I <sub>SD</sub> = 3.5 A, di/dt = 100 A/µs,	-	314		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C} \text{ (see}$ Figure 16: "Test circuit for	-	1.5		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	9.5		А

## Notes:

 $^{\left( 1\right) }$  Pulse width is limited by safe operating area.

 $^{(2)}$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5 %.









DocID025320 Rev 2



### STF5N60M2

### **Electrical characteristics**







57

DocID025320 Rev 2

# 3 Test circuits









# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.









DocID025320 Rev 2

# STF5N60M2

# Package information

12			Package information
	Table 9: TO-220FP page	ckage mechanical data	
Dim.		mm	
Dini.	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
30-Sep-2013	1	First release.
15-Jun-2016	2	Updated title, features and description in cover page. Updated Section 1: "Electrical ratings" and Section 2: "Electrical characteristics". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes.



### STF5N60M2

### IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved

